INTEGRATED CIRCUITS

DATA SHEET

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

74ABT541 Octal buffer/line driver (3-State)

Product specification Supersedes data of 1996 Sep 10 IC23 Data Handbook





Octal buffer/line driver (3-State)

74ABT541

FEATURES

- Octal bus interface
- Functions similar to the 'ABT241
- Provides ideal interface and increases fan-out of MOS Microprocessors
- Efficient pinout to facilitate PC board layout
- 3-State buffer outputs sink 64mA and source 32mA
- Power-up 3-State
- Latch-up protection exceeds 500mA per Jedec JC40.2 Std 17

- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model
- Live insertion/extraction permitted

DESCRIPTION

The 74ABT541 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT541 device is an octal buffer that is ideal for driving bus lines. The outputs are all capable of sinking 64mA and sourcing 32mA. The device features input and outputs on opposite sides of the package to facilitate printed circuit board layout.

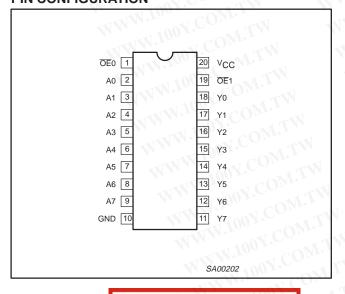
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH}	Propagation delay An to Yn	$C_L = 50pF; V_{CC} = 5V$	2.9	ns
C _{IN}	Input capacitance	V _I = 0V or V _{CC}	(4)	pF
C _{OUT}	Output capacitance	Outputs disabled; V _O = 0V or V _{CC}	N. ZOM.	pF
I _{CCZ}	Total supply current	Outputs disabled; V _{CC} = 5.5V	500	nA

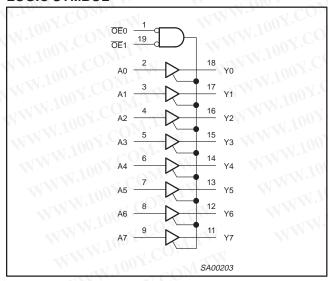
ORDERING INFORMATION

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PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
20-Pin Plastic DIP	-40°C to +85°C	74ABT541 N	74ABT541 N	SOT146-1
20-Pin plastic SO	-40°C to +85°C	74ABT541 D	74ABT541 D	SOT163-1
20-Pin Plastic SSOP Type II	-40°C to +85°C	74ABT541 DB	74ABT541 DB	SOT339-1
20-Pin Plastic TSSOP Type I	-40°C to +85°C	74ABT541 PW	74ABT541PW DH	SOT360-1

PIN CONFIGURATION



LOGIC SYMBOL

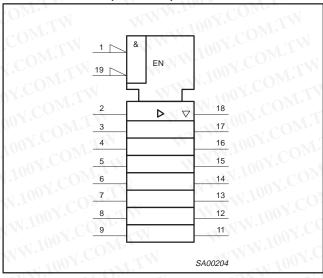


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Octal buffer/line driver (3-State)

74ABT541

LOGIC SYMBOL (IEEE/IEC)



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
2, 3, 4, 5, 6, 7, 8, 9	A0 – A7	Data inputs
18, 17, 16, 15, 14, 13, 12, 11	Y0 – Y7	Data outputs
1, 19	OE0, OE1	Output enables
10	GND	Ground (0V)
20	Vcc	Positive supply voltage

FUNCTION TABLE

N	INPUTS	TW.10	OUTPUTS
OE0	OE1	An	Yn
L L X H	L H X	L H X X	L H Z Z

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H = High voltage level

= Low voltage level

X = Don't careZ = High imped = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
Vcc	DC supply voltage	M 100Y.COM.TW	-0.5 to +7.0	VII
I _{IK}	DC input diode current	V _I < 0	-18	mA
VI	DC input voltage ³	WWW.100Y.CO.TW	-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	- 50	mA
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V.V
I _{OUT}	DC output current	output in Low state	128	mA
T _{stg}	Storage temperature range	TAM TOO COM.	-65 to 150	°C

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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74ABT541

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	Y.COB LIN	IITS	UNIT
	N WWW.100 COM. TW WWW.10	CMin	Max	1
Vcc	DC supply voltage	4.5	5.5	٧
VI	Input voltage	0.0M	V _{CC}	٧
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage	W.100 CO	0.8	V
I _{OH}	High-level output current	W.1001	-32	mA
loL	Low-level output current	W.1001.	64	mA
Δt/Δν	Input transition rise or fall rate	000	5	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

-XIVI.10	Dr. COMITY	A. TORY COM.	- 1	WW.I	LIMITS	CO_{M_I}	TIN	
SYMBOL	PARAMETER	TEST CONDITIONS	Ta	_{mb} = +25	i∘C	T _{amb} =	= –40°C 85°C	UNIT
	Ton r. COW: I.	MW.100 COM.	Min	Тур	Max	Min	Max	N
V _{IK}	Input clamp voltage	V _{CC} = 4.5V; I _{IK} = -18mA		-0.9	-1.2	V.C	-1.2	٧
MA	W.100Y.COM.TW	$V_{CC} = 4.5V$; $I_{OH} = -3mA$; $V_I = V_{IL}$ or V_{IH}	2.5	2.9	M.M	2.5	OM.	V
V_{OH}	High-level output voltage	$V_{CC} = 5.0V$; $I_{OH} = -3mA$; $V_I = V_{IL}$ or V_{IH}	3.0	3.4	-TXV.1	3.0	Mon	V
	M. T. COM. TV	$V_{CC} = 4.5V$; $I_{OH} = -32mA$; $V_I = V_{IL}$ or V_{IH}	2.0	2.4	41	2.0		V
V _{OL}	Low-level output voltage	$V_{CC} = 4.5V$; $I_{OL} = 64mA$; $V_I = V_{IL}$ or V_{IH}	N	0.42	0.55	100	0.55	V
l _l	Input leakage current	V _{CC} = 5.5V; V _I = GND or 5.5V	CVV	±0.01	±1.0	N. 3	±1.0	μА
I _{OFF}	Power-off leakage current	$V_{CC} = 0.0V; V_{I} \text{ or } V_{O} \le 4.5V$		±5.0	±100	W.In	±100	μА
I _{PU} /I _{PD}	Power-up/down 3-state output current ³	V_{CC} = 2.0V; V_{O} = 0.5V; V_{I} = GND or V_{CC} ; V_{OE} = Don't care	TV	±5.0	±50	W.I	±50	μА
I _{OZH}	3-State output High current	$V_{CC} = 5.5V$; $V_O = 2.7V$; $V_I = V_{IL}$ or V_{IH}	11.	5.0	50	MM.	50	СμΑ
I _{OZL}	3-State output Low current	$V_{CC} = 5.5V; V_O = 0.5V; V_I = V_{IL} \text{ or } V_{IH}$	Mr.	-5.0	-50	UWW	-50	μΑ
I _{CEX}	Output High leakage current	$V_{CC} = 5.5V$; $V_O = 5.5V$; $V_I = GND$ or V_{CC}	OM.	5.0	50		50	μА
ΙO	Output current ¹	$V_{CC} = 5.5V; V_{O} = 2.5V$	-40	-100	-180	-40	-180	mA
I _{CCH}	MANA TOOK	V_{CC} = 5.5V; Outputs High, V_I = GND or V_{CC}		0.5	250	11/1	250	μА
I _{CCL}	Quiescent supply current	$V_{CC} = 5.5V$; Outputs Low, $V_I = GND$ or V_{CC}	CO	24	30	W	30	mA
I _{CCZ}	WWW.100	V_{CC} = 5.5V; Outputs 3-State; V_I = GND or V_{CC}	N.CC	0.5	250	V	250	μА
	WWW.10	Outputs enabled, one input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V	107.C	0.5	1.5		1.5	mA
ΔI_{CC}	Additional supply current per input pin ²	Outputs 3-State, one data input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V	001	0.5	50		50	μА
	MMM	Outputs 3-State, one enable input at 3.4V, other inputs at $V_{\rm CC}$ or GND; $V_{\rm CC}$ = 5.5V	100	0.5	1.5	N	1.5	mA

NOTES:

- 1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- 2. This is the increase in supply current for each input at 3.4V.
- 3. This parameter is valid for any V_{CC} between 0V and 2.1V with a transition time of up to 10msec. For V_{CC} = 2.1V to V_{CC} = 5V ± 10%, a transition time of up to 100µsec is permitted.

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Octal buffer/line driver (3-State)

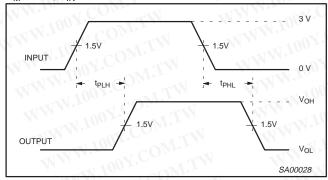
74ABT541

AC CHARACTERISTICS

TIMO	W 1001.	OWITH	N. T.	JW.100	LIMI	TS		
SYMBOL	PARAMETER	WAVEFORM	T,	_{amb} = +25 CC = +5.0	°C V	T _{amb} = -40 V _{CC} = +5	°C to +85°C .0V ±0.5V	UNIT
	TWW.100	COM.	Min	Тур	Max	Min	Max	
t _{PLH}	Propagation delay An to Yn	Y.COM.	1.0 1.0	2.6 2.9	4.1 4.2	1.0	4.6 4.6	ns
t _{PZH}	Output enable time to High and Low level	0 2 M.TV	1.1 2.1	3.1 4.4	4.8 5.9	1.1 2.1	5.3 6.4	ns
t _{PHZ}	Output disable time from High and Low level	20M.1	2.1 1.7	5.1 4.7	6.6 6.2	2.1 1.7	7.1 6.7	ns

AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to 3.0V

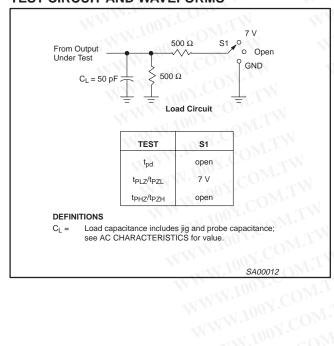


Waveform 1. Waveforms Showing the Input (An) to Output (Yn) **Propagation Delays**

OEn ٧M ٧M INPLIT tPZL tPLZ 3.5V Yn VOL + 0.3VOUTPUT VOL tPHZ ^tPZH VOH VOH - 0.3V OUTPUT

Waveform 2. Waveforms Showing the 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS



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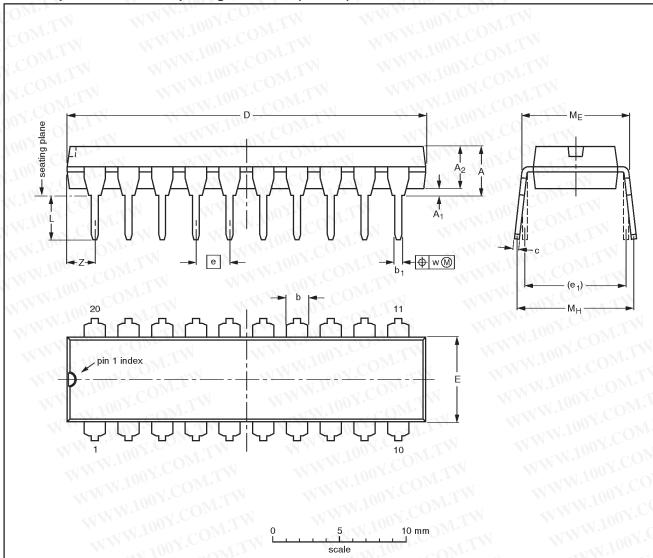
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74ABT541

DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	(e	e ₁	Mr.	ΜE	Мн	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

VERSION	IEC					
	iLO	JEDEC	EIAJ	WWW.I	PROJECTION	ISSUE DATE
SOT146-1		M.100 x. CO.	SC603	WWW.10		92-11-17 95-05-24
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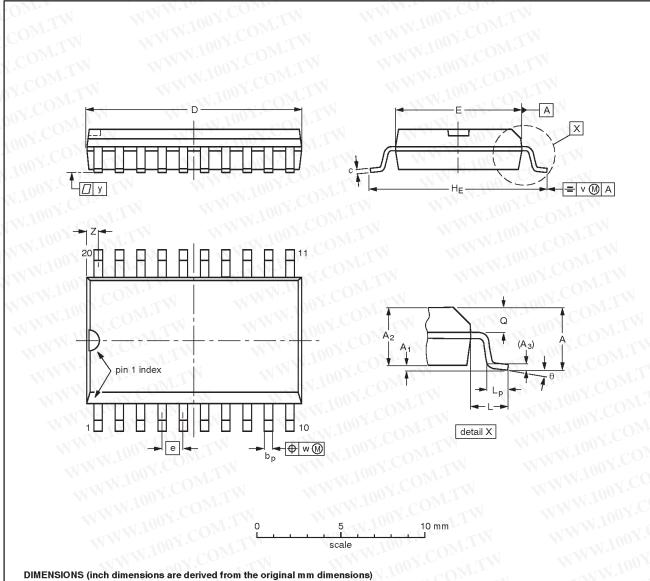
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Octal buffer/line driver (3-State)

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	C.	D ⁽¹⁾	E ⁽¹⁾	е	HE	750	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016		0.01	0.01	0.004	0.035 0.016	0°

Note

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VERSION	IEC	JEDEC	EIAJ	TIM W.Io	PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC	W.I.A.	WWW.I		92-11-17 95-01-24

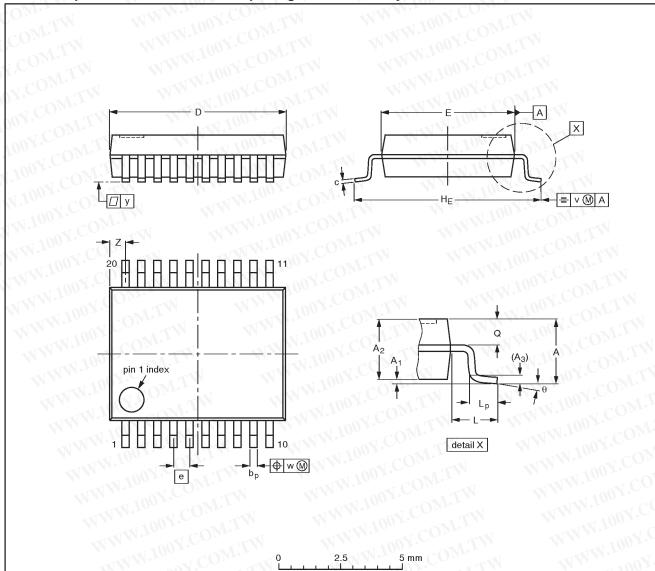
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Octal buffer/line driver (3-State)

74ABT541

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	c	D ⁽¹⁾	E ⁽¹⁾	е	HE	N 50,	Lp	Q	V	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

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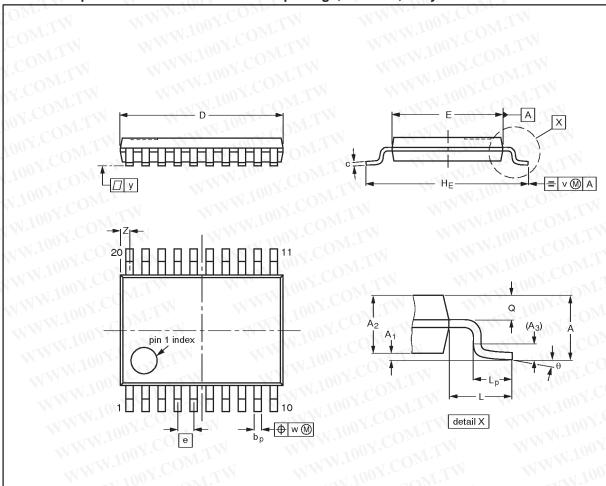
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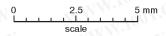
Octal buffer/line driver (3-State)

74ABT541

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1





DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bp	C	D ⁽¹⁾	E ⁽²⁾	е	HE	150	Lp	Q	V	w	У	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4	0.2	0.13	0.1	0.5 0.2	8° 0°
Notes 1. Plastic	or meta	al protru	sions of	0.15 mi	m maxin	num per	side are	e not inc	luded.	W		100	7.CO	OM.	TW		WV	WV
2. Plastic																		

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFERE	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	WWW.	PROJECTION	ISSUE DATE
SOT360-1	W.	MO-153AC	V.I.	MMM'I		93-06-16 95-02-04
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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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